

# APD Series: Silicon PIN Diodes, Packaged and Bondable Chips

## Applications

- Switches
- Attenuators

## Features

- Established Skyworks PIN diode process
- Low capacitance designs to 0.05 pF
- Voltage ratings to 200 V
- Chip size < 15 mils square
- Tight control of I layer base width
- Mesa and planar chip designs



Skyworks Green™ products are compliant with all applicable legislation and are halogen-free. For additional information, refer to *Skyworks Definition of Green™*, document number SQ04-0074.



## Description

Skyworks APD series of silicon PIN diodes are designed for use as switch and attenuator devices in high-performance RF and microwave circuits. The PIN diode designs are useful over a wide range of frequencies from below 100 MHz to beyond 30 GHz. These devices use Skyworks well-established silicon technology resulting in PIN diodes with tightly controlled I-region characteristics.

The low capacitance and low resistance of the APD0505 through APD1520 diodes are ideal for switch applications that require insertion loss and fast switching speed. For switch or attenuator applications requiring high power and low distortion, the thick I-region and high reverse breakdown voltage of the APD2220 is ideal.

The absolute maximum ratings of the APD diode series are provided in Table 1. Electrical specifications are provided in Table 2. Table 3 identifies the die part numbers with their corresponding top contact diameters and die outline drawings. Table 4 identifies the hermetic part numbers together with their thermal resistance specifications and hermetic outline drawings. Typical performance characteristics are provided in Figures 1 through 8.

**Table 1. APD Series Absolute Maximum Ratings**

Parameter	Symbol	Minimum	Typical	Maximum	Units
Power dissipation	P <sub>DIS</sub>			$\frac{\text{Maximum } T_J - \text{Case Temp}}{\text{Thermal Resistance}_{\text{junction-to-case}}}$	W
Reverse voltage	V <sub>R</sub>			See Voltage Rating column in Table 2	V
Forward current	I <sub>F</sub>			200	mA
Operating temperature	T <sub>OP</sub>	-65		+175	°C
Storage temperature	T <sub>STG</sub>	-65		+200	°C

**Note:** Exposure to maximum rating conditions for extended periods may reduce device reliability. There is no damage to device with only one parameter set at the limit and all other parameters set at or below their nominal value. Exceeding any of the limits listed here may result in permanent damage to the device.

**CAUTION:** Although this device is designed to be as robust as possible, electrostatic discharge (ESD) can damage this device. This device must be protected at all times from ESD. Static charges may easily produce potentials of several kilovolts on the human body or equipment, which can discharge without detection. Industry-standard ESD precautions should be used at all times.

**Table 2. APD Series Electrical Specifications (Note 1)**

(T<sub>OP</sub> = +25 °C, Unless Otherwise Noted)

Parameter	Junction Capacitance (C <sub>J</sub> ) V <sub>R</sub> = 50 V, 1 MHz (pF)	Junction Capacitance (C <sub>J</sub> ) V <sub>R</sub> = 0 V, 1 MHz (pF)	Series Resistance (R <sub>S</sub> ), I = 10 mA, 500 MHz (Ω)	Minority Carrier Lifetime (T <sub>L</sub> ) I = 10 mA (ns)	Voltage Rating (Note 2) (V)	I-Region Thickness (μm)	Thermal Resistance (θ <sub>JC</sub> ) (°C/W)
	Maximum	Typical	Maximum	Typical		Nominal	Maximum
<b>Switching Applications</b>							
APD0505-000	0.05	0.10	2.5	70	50	5	118
APD0510-000	0.10	0.20	1.5	90	50	5	76
APD0520-000	0.20	0.25	1.0	120	50	5	55
APD0805-000	0.05	0.10	2.0	100	100	8	87
APD0810-000	0.10	0.15	1.5	160	100	8	60
APD1505-000	0.06 @ 10 V	0.12	2.5	350	200	15	60
APD1510-000	0.10	0.20	2.0	300	200	15	56
APD1520-000	0.20	0.25	1.2	900	200	15	44
<b>Attenuator Applications</b>							
APD2220-000	0.20	0.35	4.0	700	100	50	18

**Note 1:** Performance is guaranteed only under the conditions listed in this table.

**Note 2:** Reverse current is specified at 10 μA maximum at the voltage rating noted. Do not exceed this voltage.

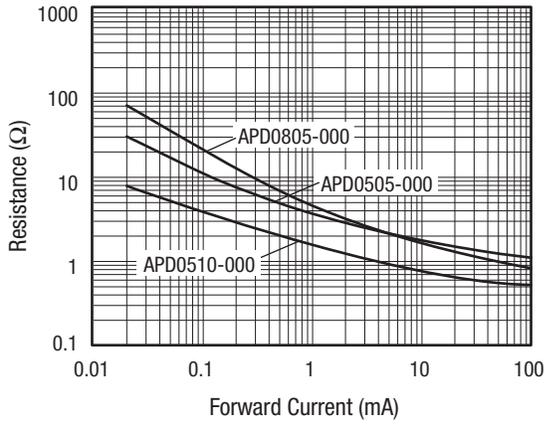
**Table 3. APD Series Parts**

Part Number	Top Contact Diameter (±0.5 mils)	Die Drawing
<b>Switching Applications</b>		
APD0505-000	1.50	150-806
APD0510-000	2.30	150-801
APD0520-000	3.05	150-801
APD0805-000	2.25	150-801
APD0810-000	3.05	150-801
APD1505-000	2.75	150-806
APD1510-000	3.50	150-813
APD1520-000	5.00	150-802
<b>Attenuator Applications</b>		
APD2220-000	8.50	149-815

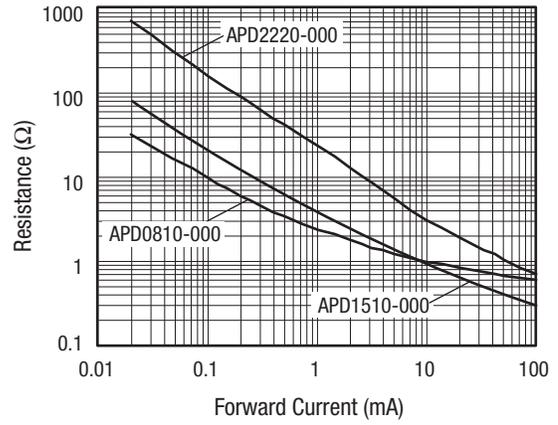
**Table 4. Hermetic Packages**

Hermetic Stripline Drawing	Typical Thermal Resistance (θ <sub>jc</sub> ) (°C/W)	Hermetic Pill Drawing	Typical Thermal Resistance (θ <sub>jc</sub> ) (°C/W)	Hermetic Pill Drawing	Typical Thermal Resistance (θ <sub>jc</sub> ) (°C/W)	Hermetic Pill Drawing	Typical Thermal Resistance (θ <sub>jc</sub> ) (°C/W)
APD0505-240	214	APD0505-203	232	APD0505-210	133	APD0505-219	201
APD0510-240	170	APD0510-203	189	APD0510-210	90	APD0510-219	158
APD0520-240	148	APD0520-203	167	APD0520-210	59	APD0520-219	136
APD0805-240	182	APD0805-203	201	APD0805-210	107	APD0805-219	170
APD0810-240	155	APD0810-203	174	APD0810-210	75	APD0810-219	143
APD1505-240	150	APD1505-203	172	APD1505-210	74	APD1505-219	142
APD1510-240	149	APD1510-203	168	APD1510-210	70	APD1510-219	137
APD1520-240	136	APD1520-203	155	APD1520-210	57	APD1520-219	124
APD2220-240	115	APD2220-203	132	APD2220-210	32	APD2220-219	104

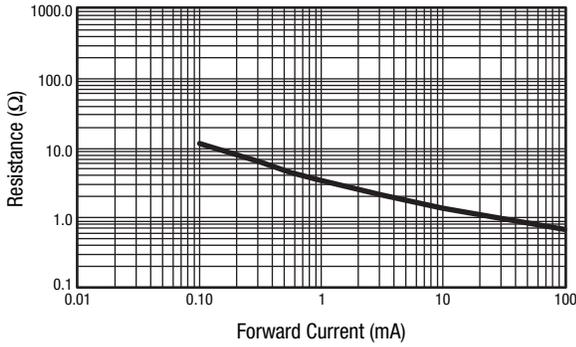
**Typical Performance Characteristics at 25 °C**



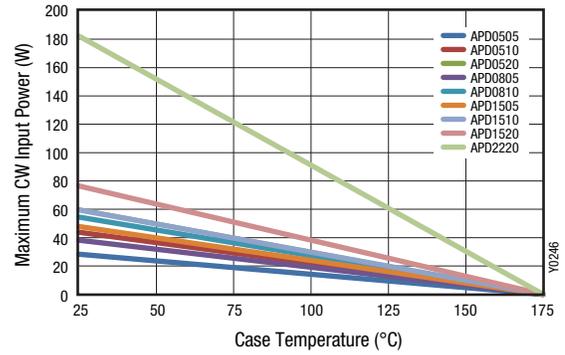
**Figure 1. Resistance vs Forward Current @ 1 GHz**



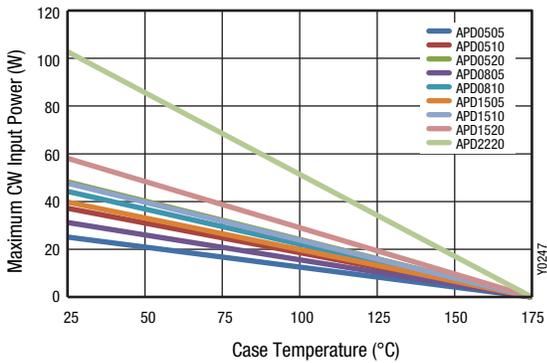
**Figure 2. Resistance vs Forward Current @ 1 GHz**



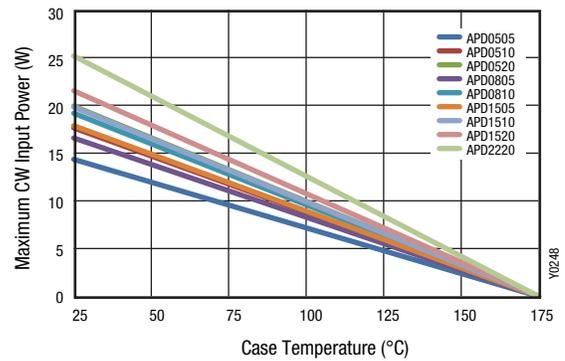
**Figure 3. Resistance vs Forward Current @ 500 MHz (APD1505-000 Package)**



**Figure 4. Maximum CW Input Power vs Case Temperature (-000 Package)**



**Figure 5. Maximum CW Input Power vs Case Temperature (-210 Package)**



**Figure 6. Maximum CW Input Power vs Case Temperature (-203 Package)**

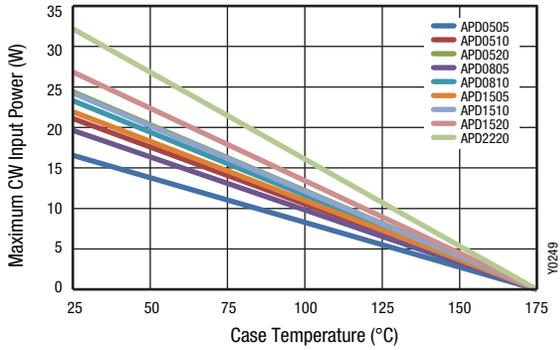


Figure 7. Maximum CW Input Power vs Case Temperature (-219 Package)

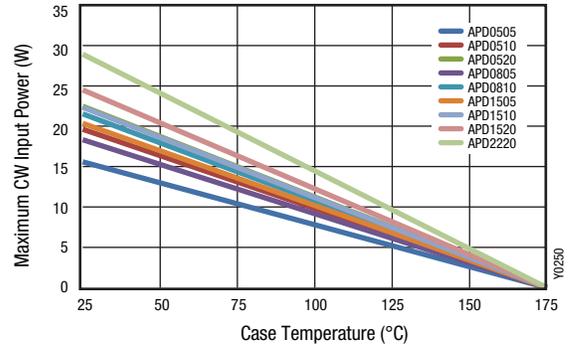


Figure 8. Maximum CW Input Power vs Case Temperature (-240 Package)

### Package Outline Drawings

Package outline die drawings for the APD diode series are shown in Figures 9 and 10. Hermetic package outlines are shown in Figures 11 through 14.

### Die Packages

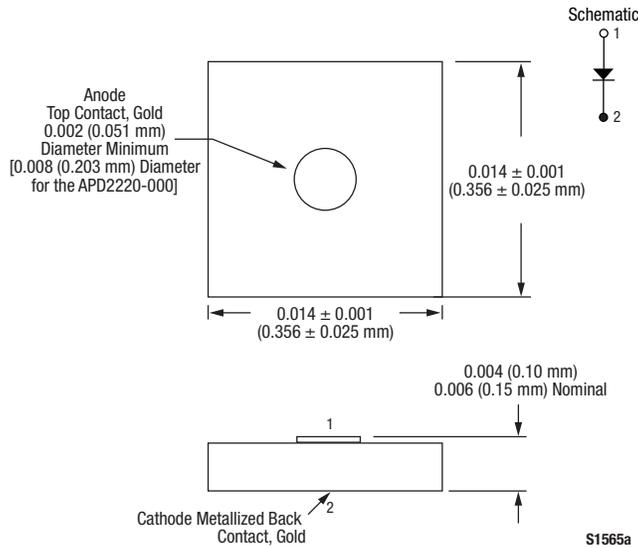
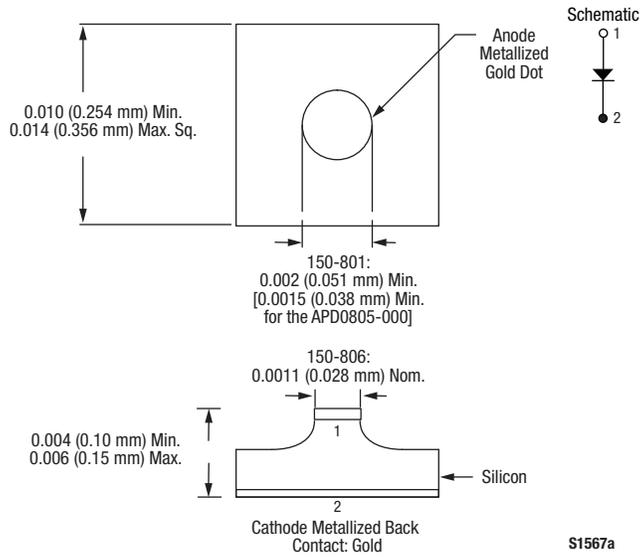


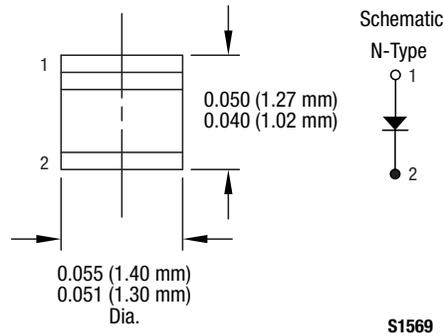
Figure 9. 149-815 Package

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**Figure 10. 150 Series Package**

**Hermetic Packages**



**Figure 11. -203 Package**

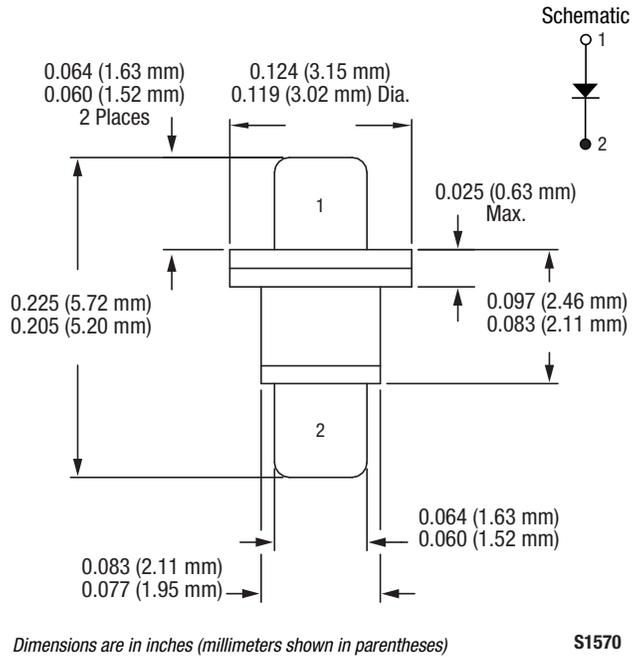


Figure 12. -210 Package

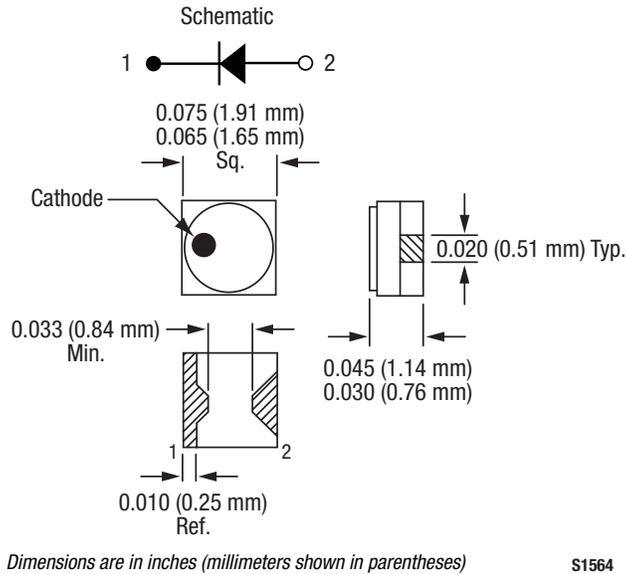
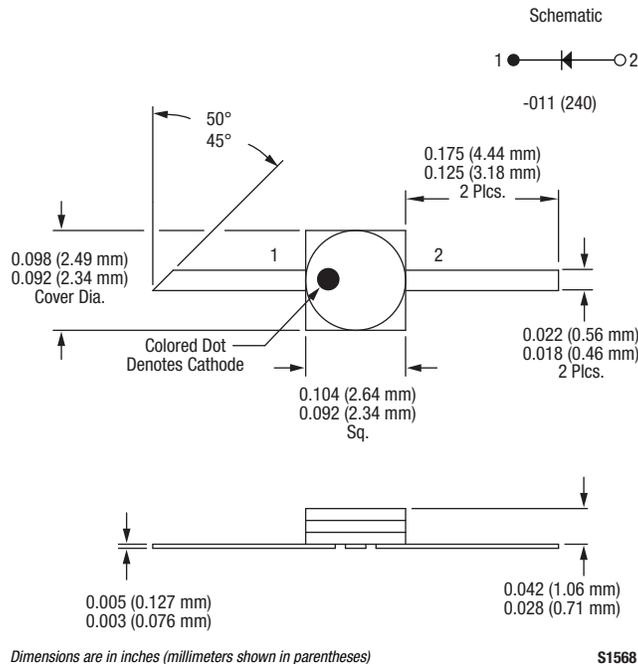


Figure 13. -219 Package

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**Figure 14. -240 Package**

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